# Product End-of-Life Disassembly Instructions

**Product Category:** Multi-functional Devices

**Marketing Name / Model**

- HP LaserJet 9000mfp/C8523A
- HP LaserJet 9000Lmfp/Q2622A

## Purpose:
The document is intended for use by end-of-life recyclers or treatment facilities. It provides the basic instructions for the disassembly of HP products to remove components and materials requiring selective treatment, as defined by EU directive 2002/96/EC, Waste Electrical and Electronic Equipment (WEEE).

### 1.0 Items Requiring Selective Treatment

1.1 Items listed below are classified as requiring selective treatment.

1.2 Enter the quantity of items contained within the product which require selective treatment in the right column, as applicable.

<table>
<thead>
<tr>
<th>Item Description</th>
<th>Notes</th>
<th>Quantity of items included in product</th>
</tr>
</thead>
<tbody>
<tr>
<td>Printed Circuit Boards (PCB) or Printed Circuit Assemblies (PCA)</td>
<td>With a surface greater than 10 sq cm 9000 9000L</td>
<td>qty/model unknown unknown</td>
</tr>
<tr>
<td>Batteries</td>
<td>All types including standard alkaline and lithium coin button style batteries [not present]</td>
<td>0</td>
</tr>
<tr>
<td>Mercury-containing components</td>
<td>For example, mercury in lamps, display backlights, scanner lamps, switches, batteries - Control panel display backlight</td>
<td>1</td>
</tr>
<tr>
<td>Liquid Crystal Displays (LCD) with a surface greater than 100 sq cm</td>
<td>Includes background illuminated displays with gas discharge lamps - Control panel display</td>
<td>1</td>
</tr>
<tr>
<td>Cathode Ray Tubes (CRT)</td>
<td>[not present]</td>
<td>0</td>
</tr>
<tr>
<td>Capacitors / condensers (Containing PCB/PCT)</td>
<td>[not present]</td>
<td>0</td>
</tr>
<tr>
<td>Electrolytic Capacitors / Condensers measuring greater than 2.5 cm in diameter or height</td>
<td>Unknown</td>
<td>unknown</td>
</tr>
<tr>
<td>External electrical cables and cords</td>
<td>- power cord</td>
<td>1</td>
</tr>
<tr>
<td>Gas Discharge Lamps</td>
<td>[not present]</td>
<td>0</td>
</tr>
<tr>
<td>Plastics containing Brominated Flame Retardants</td>
<td>Plastic parts installed in close proximity to heating/fusing units and paper path parts contain brominated flame retardants. Further, industry standard parts including fans, motors, cables, connectors, wiring and printed circuit boards also molded plastic parts:</td>
<td></td>
</tr>
</tbody>
</table>
Components and parts containing toner and ink, including liquids, semi-liquids (gel/paste) and toner
typically contain these flame retardants.
9000
9000L
See note 2.
all motors, fans, connectors, wiring and PC boards

Components and waste containing asbestos
[not present]
0

Components, parts and materials containing refractory ceramic fibers
[not present]
0

Components, parts and materials containing radioactive substances
[not present]
0

2.0 Tools Required
List the type and size of the tools that would typically be used to disassemble the product to a point where components and materials requiring selective treatment can be removed.

<table>
<thead>
<tr>
<th>Tool Description</th>
<th>Tool Size (if applicable)</th>
</tr>
</thead>
<tbody>
<tr>
<td>Use standard hand tools</td>
<td></td>
</tr>
</tbody>
</table>

3.0 Product Disassembly Process
3.1 List the basic steps that should typically be followed to remove components and materials requiring selective treatment:

1. Remove toner cartridge.
2. Remove the outer housing skins and sort according to markings. Assume all remaining molded plastic parts contain brominated flame retardants.
3. Disassemble the chassis using appropriate tools and set aside items requiring selective treatment.
4. 
5. 
6. 
7. 
8. 

3.2 Optional Graphic. If the disassembly process is complex, insert a graphic illustration below to identify the items contained in the product that require selective treatment (with descriptions and arrows identifying locations).